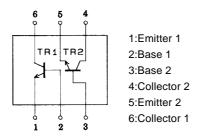


# FC152

# PNP Epitaxial Planar Silicon Composite Transistor High-Frequency Amp, Differential Amp Applications

#### **Features**

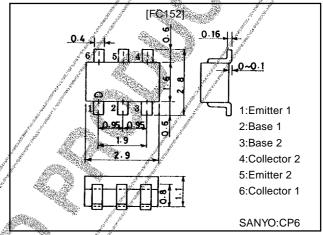
- · Composite type with 2 transistors contained in the CP package currently in use, improving the mounting efficiency greatly.
- The FC152 is formed with two chips, being equivalent to the 2SC4270, placed in one package.
- · Excellent in thermal equilibrium, pair capability and especially suited for differential amp.



## **Package Dimensions**

unit:mm

2104A



# **Specifications**

Absolute Maximum Ratings at Ta = 25°C

Parameter		Symbol Conditions	Ratings	Unit
Collector-to-Base Voltage		Усво	25	V
Collector-to-Emitter Voltage	, i de de la companya	VCEQ	15	V
Emitter-to-Base Voltage	11	VEBO	3	V
Collector Current	A. Mark	(C)	50	mA
Collector Dissipation	John Janes	APC Punit	200	mW
Total Dissipation	II a	(* P4)	300	mW
Junction Temperature	11	Тј	150	°C
Storage Temperature	1 1 10000	Tistg //	-55 to +150	°C

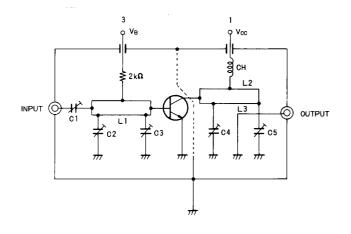
## Electrical Characteristics at Ta = 25°C

Parameter	Symbol	Conditons		Ratings		Unit
	Symbol	Conditions	min	typ	max	Offic
Collector Cutoff Current	IÇBØ	V <sub>CB</sub> =20V, I <sub>E</sub> =0			0.1	μA
Emitter Cutoff Current	<sup>A</sup> EBO	V <sub>EB</sub> =2V, I <sub>C</sub> =0			10	μA
DC Current Gain	√ h <sub>FE</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =5mA	60		200	
DC Current Gain Ratio	FE(small/	V <sub>CE</sub> =10V, I <sub>C</sub> =5mA	0.7	0.95		
	large)					
B-E Voltage Difference	V <sub>BE</sub> (large-	V <sub>CE</sub> =10V, I <sub>C</sub> =0		3.0	10	mV
	small)					
Gain/Briadwidth Product	fΤ	V <sub>CE</sub> =10V, I <sub>C</sub> =10mA	1.5	3.0		GHz
Output Capacitance	Cob	V <sub>CB</sub> =10V, f=1MHz		0.7	1.0	pF
Power Gain	PG	V <sub>CE</sub> =10V, I <sub>C</sub> =10mA, f=0.9GHz		12		dB
Noise Figure	NF	V <sub>CE</sub> =10V, I <sub>C</sub> =3mA, f=0.9GHz		3.0		dB

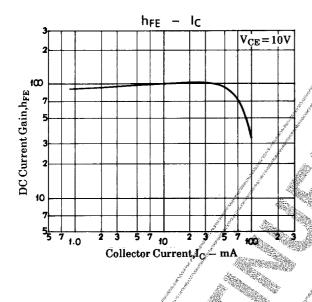
Note: The specifications shown above are for each individual transistor. However, the specifications of  $h_{FE}$  (small/large) and  $V_{BE}$  (large-small) are for pair capability

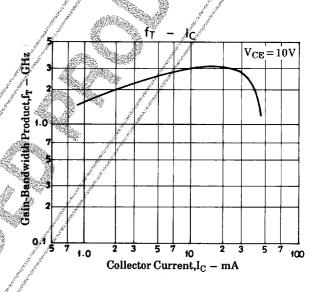
Marking:152

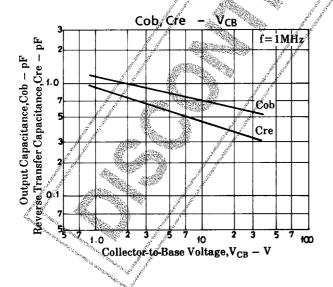
## **PG, NF Test Circuit**

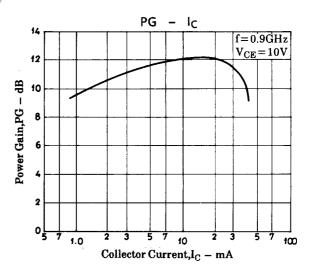


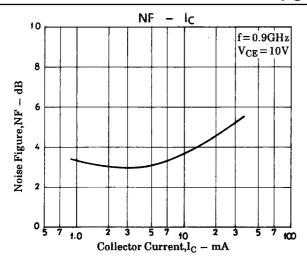
	900MHz					
C1	~5pF					
C2	~10pF					
C3	~10pF					
C4	~10pF					
C5	~10pF					
L1	~10pF W≒1.5mm, 1≓25mm strip line					
L2						
L3	0.5 ø, 1 = 40mm					
СН	W=4mm, 1=25mm strip line 0.5\$\rho\$, \$\text{\$k\$} = 40mm 2t + bead core					

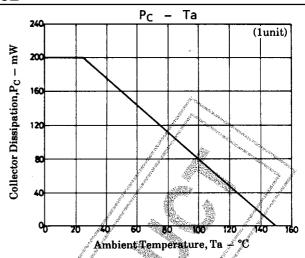








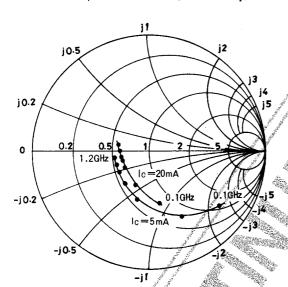




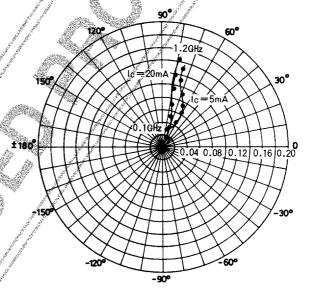
## **S Parameter**

 $S11e: V_{CE} = 10V$ 

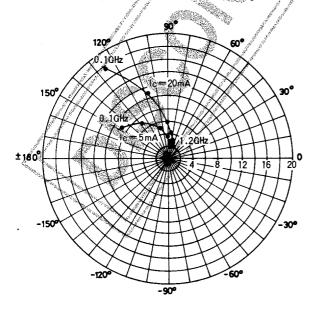
f = 100MHz, 200 to 1200MHz (200MHz step)



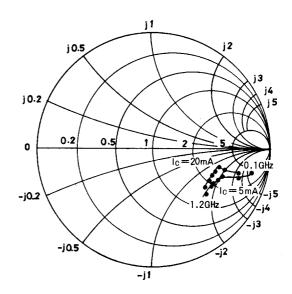
S12e  $V_{CE} = 10V$ f = 100MHz, 200 to 1200MHz (200MHz step)



 $S21e: V_{CE} = 10V \\ f = 100MHz, 200 to 1200MHz (200MHz step)$ 







### S Parameter (Common-emitter)

 $V_{CE} = 10V, I_{C} = 5mA, Z_{O} = 50\Omega$ 

							,	
Freq (MHz)	S <sub>11</sub>	∠S <sub>11</sub>	S <sub>21</sub>	∠S <sub>21</sub>	S <sub>12</sub>	∠S <sub>12</sub>	S <sub>22</sub> †	∠S <sub>22</sub>
100	0.771	-35.1	8.763	147.2	0.027	69.3	0.890	-14.2
200	0.613	-64.7	7.004	127.6	0.043	59.8	0.780	-19.7
400	0.429	-110.7	4.882	103.1	0.061	58.1	0.660	-22.8
600	0.361	-133.5	3.471	90.5	0.075	63.1	0.625	-25.1
800	0.355	-148.4	2.693	81.6	0.091	68.1	0.612	-28.6
900	0.331	- 153.7	2.450	78.9	0.100	70.5	0.609	- 29.9
1000	0.328	-158.9	2.236	75.5	0.110	72.5	0.607	-31.6
1200	0.326	-167.9	1.932	69.9	0.130	74.7	0.608	35.7

 $V_{CE} = 10V, I_{C} = 20mA, Z_{O} = 50\Omega$ 

CE 1	-0 -0	0				# Marchine	100	1 1
Freq (MHz)	S <sub>11</sub>	∠S <sub>11</sub>	S <sub>21</sub>	∠S <sub>21</sub>	S <sub>12</sub>	<b>∠</b> \$ <sub>12</sub>	<b>N</b>   S <sub>22</sub>   ∕	√ ∠S <sub>22</sub>
100	0.447	-78.1	17.728	125.0	0.029	66.0	0.752	-18.5
200	0.338	-113.2	10.936	107.5	0.031	66.5	0.639	-18.5
400	0.290	-146.6	5.773	91.4	0.052	72.1	0.580	-18.5
600	0.281	-159.3	3.956	83.0	0.074	75.7	0.571	-21.1
800	0.285	-168.8	2.982	76.2	0.095	77.6	<b>0.566</b>	-25.2
900	0.289	-171.3	2.703	74.0	0.106	78.6	0.563	-26.7
1000	0.291	-174.4	2.454	71,3	0.118	79,4	0.565	-28.6
1200	0.297	178.1	2.116	66.5	0.140	79.0	0.569	-33.1

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